NPN Silicon Power Transistor

DPAK for Surface Mount Applications

Designed for general purpose amplifier and low speed switching applications.

Features

- High Gain
- Low Saturation Voltage
- High Current Gain Bandwidth Product
- Epoxy Meets UL 94 V-0 @ 0.125 in
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS

			1
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	45	Vdc
Collector-Base Voltage	V _{CB}	45	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current – Continuous	Ι _C	4.0	Adc
Collector Current – Peak	I _{CM}	7.0	Adc
Base Current	Ι _Β	50	mAdc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	20 0.16	W W/°C
Total Power Dissipation (Note 1) @ $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	PD	1.75 0.014	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C
ESD – Human Body Model	HBM	3B	V
ESD – Machine Model	MM	С	V

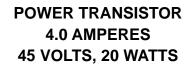
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

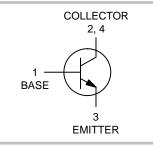
1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.



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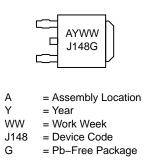
www.onsemi.com







MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
MJD148T4G	DPAK (Pb-Free)	2,500/Tape & Reel
NJVMJD148T4G	DPAK (Pb-Free)	2,500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MJD148

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ extsf{ heta}JC}$	6.25	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	71.4	°C/W

2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

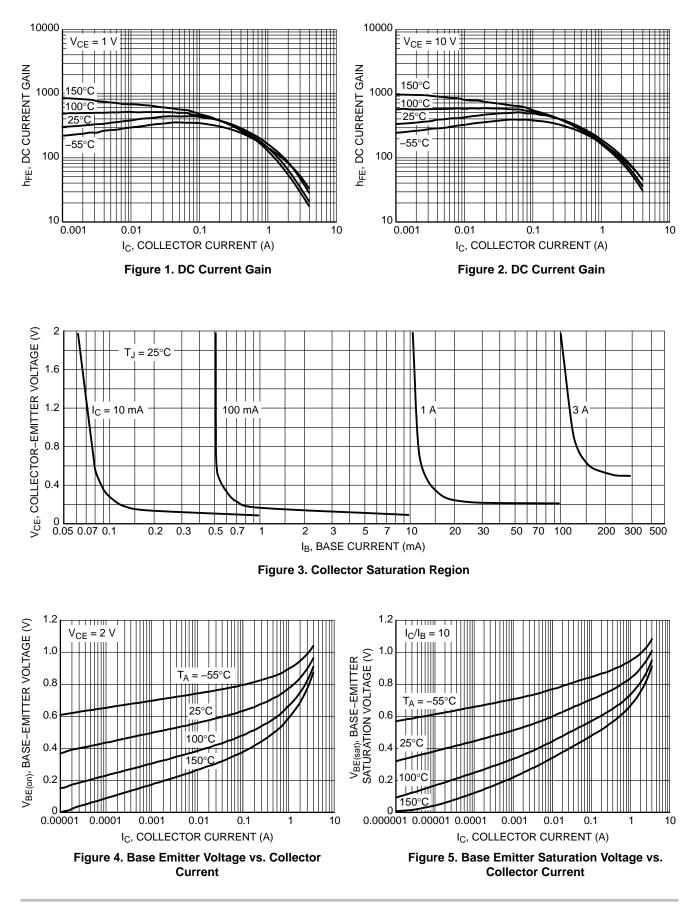
ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$, unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		L		4
Collector–Emitter Sustaining Voltage (Note 3) $(I_{C} = 100 \text{ mAdc}, I_{B} = 0)$	V _{CEO(sus)}	45	-	Vdc
Collector Cutoff Current ($V_{CB} = 45 \text{ Vdc}, I_E = 0$)	I _{CBO}	_	20	μAdc
Emitter Cutoff Current ($V_{BE} = 5 \text{ Vdc}, I_C = 0$)	I _{EBO}	-	1	mAdc
ON CHARACTERISTICS (Note 3)				
	h _{FE}	40 85 50 30	- 375 -	_
Collector–Emitter Saturation Voltage $(I_{C} = 2 \text{ Adc}, I_{B} = 0.2 \text{ Adc})$	V _{CE(sat)}	-	0.5	Vdc
Base–Emitter On Voltage (I _C = 2 Adc, V _{CE} = 1 Vdc)	V _{BE(on)}	-	1.1	Vdc
DYNAMIC CHARACTERISTICS				
Current–Gain–Bandwidth Product ($I_C = 250 \text{ mAdc}, V_{CE} = 1 \text{ Vdc}, f = 1 \text{ MHz}$)	f _T	3	-	MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

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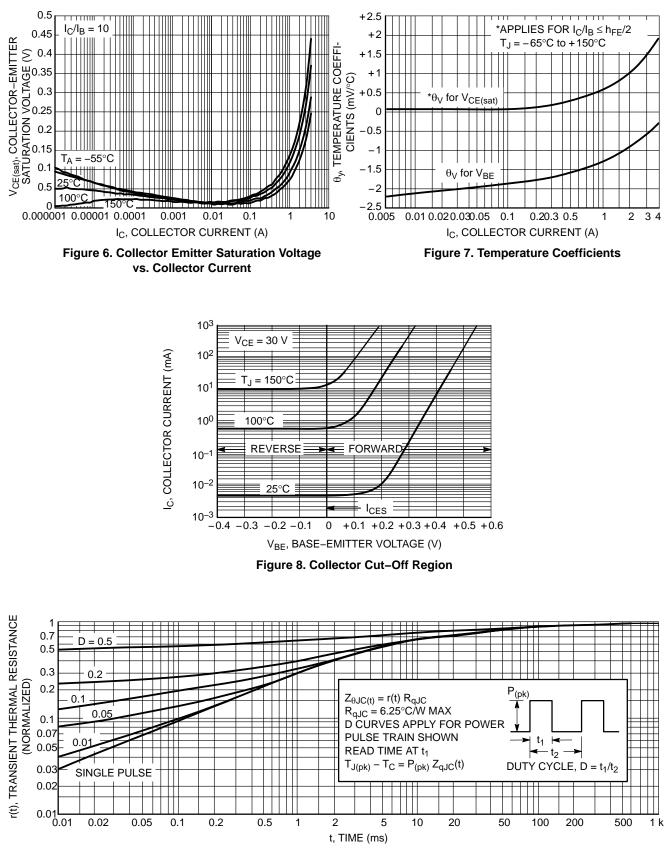


Figure 9. Thermal Response

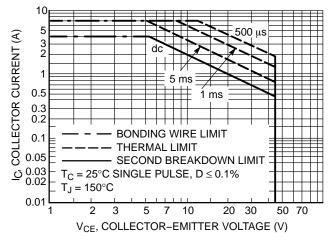


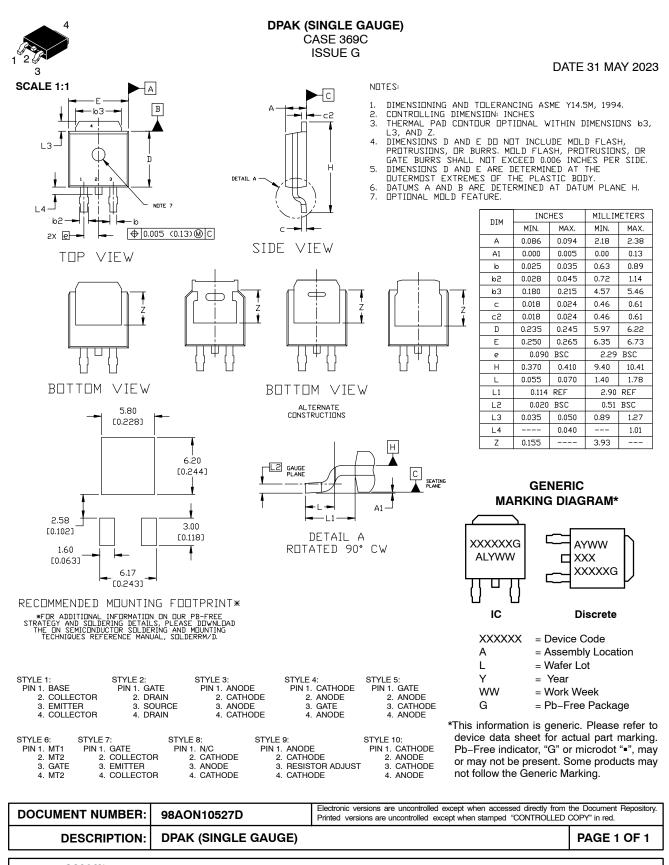
Figure 10. Maximum Rated Forward Bias

Forward Bias Safe Operating Area Information

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 10 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 9. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

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